



# APPLICATION DATA SHEET

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<b>Title of Invention</b>	SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME		
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Inventor Information: <u>Inventor 1:</u> <b>Applicant Authority Type:</b> Inventor <b>Citizenship:</b> JP <b>Given Name:</b> Takuji <b>Family Name:</b> TANAKA <b>Residence:</b> <b>City of Residence:</b> Kawasaki <b>Country of Residence:</b> JP <b>Address-1 of Mailing Address:</b> c/o FUJITSU LIMITED <b>Address-2 of Mailing Address:</b> 1-1, Kamikodanaka 4-chome, Nakahara-ku <b>City of Mailing Address:</b> Kawasaki <b>State of Mailing Address:</b> <b>Postal Code of Mailing Address:</b> 211-8588 <b>Country of Mailing Address:</b> JP <b>Phone:</b> <b>Fax:</b> <b>E-mail:</b>			
Attorney Information: practitioner(s) at Customer Number: 23850 			

as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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Assignee 1:

**Organization Name:**

FUJITSU LIMITED

**Address-1 of Mailing Address:**

1-1, Kamikodanaka 4-chome

**Address-2 of Mailing Address:**

Nakahara-ku

**City of Mailing Address:**

Kawasaki

**State of Mailing Address:**

**Postal Code of Mailing Address:**

211-8588

**Country of Mailing Address:**

JP

**Phone:**

**Fax:**

**E-mail:**